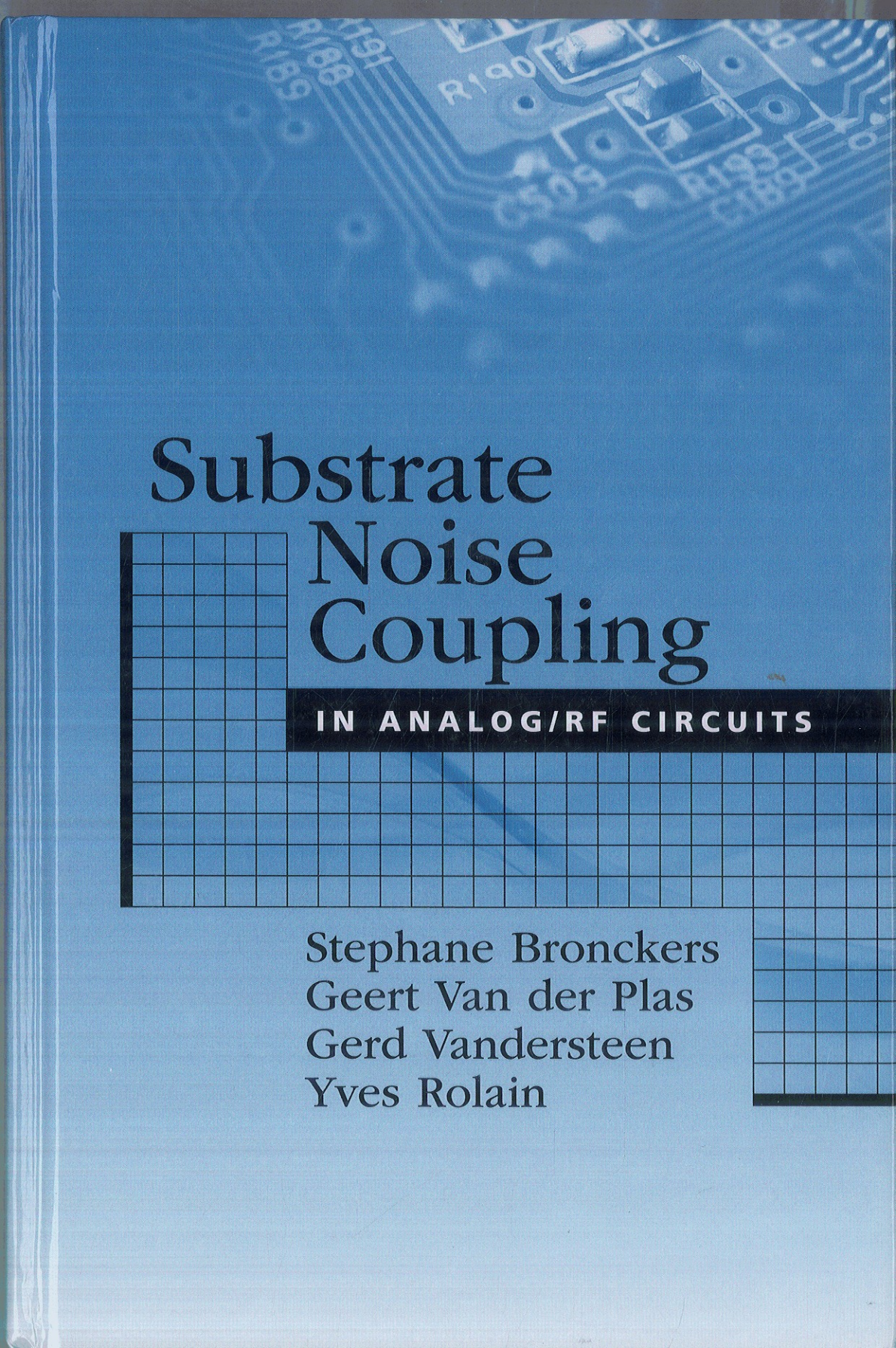




Substrate Noise Coupling

IN ANALOG/RF CIRCUITS

Stephane Bronckers
Geert Van der Plas
Gerd Vandersteen
Yves Rolain

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